L1

L2

L3

L4

L6

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(FILE 'HOME' ENTERED AT 00:02:19 ON 08 JU
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FILE 'HCAPLUS, INSPEC, JAPIO, USPATFULL, USPAT2' ENTERED AT 00:06:15 ON 08 JUN 2006

42588 S (CZ OR CZOCHRALSKI)

137810 S (PHOSPHORUS OR P) (8A) (DOP?)

64195 S (N(W) TYPE) (8A) (SI OR SILICON) 525169 S (SINGLE OR MONO) (8A) (CRYSTAL?)

L5 449553 S (WAFER#)

56404 S (DOP?)(8A)(AL OR ALUMINIUM OR ALUMINUM)

L7 3545513 S (AL OR ALUMINUM OR ALUMINIUM)

1570 S (ATOMS(W)CC)

=> s 11 and 12 and 13 and 14 and 15 and 16 and 17 and 18

6 L1 AND L2 AND L3 AND L4 AND L5 AND L6 AND L7 AND L8

=> d 19 1-6 abs, bib

ANSWER 1 OF 6 HCAPLUS COPYRIGHT 2006 ACS on STN L9

A process for producing a P-doped Si single crystal by Czochralski method is described, which is characterized in that a single crystal is grown such that at least Al concentration is 2 7 1012 /cc. A process for producing a P-dored si /cc. A process for producing a P-dep

single crystal including no defeative region region, an OSF region or again dislocation and having excellent elec gharacteristics of Laster (LSEPD, LFPD) region, stics 🗗 high withstand voltage

easily and inexpensively 2004:634119 HCAPINS

ΑN DN

single crystal and P-doped in type silicon single wafer TIc≰ng P-doped silii

ΙN Sakurada phiro; Fusegawa, PA Shin-Ets Handotai Cd.

PCT Int. Appl., 21 pp SO

CODEN: PIXXD2

DT Patent

LA Japanese

FAN.CNT 1

	PATENT NO.)	DATE		APPLICATION NO.						DATE			
PI	WO 2004065666					A1		20040805		WO 2003-JP16794						20031225			
			CN,	,		CII	CV	C7	חר	DI		EC		ED	- CP	CD		7.17	
		EVV :									EE, SK,		ĽΙ,	rK,	GB,	GK,	HU,	IE,	
	JP 2004224577 EP 1591566										JP 2003-10436					20030117			
						A1 20051102				EP 2003-768274					20031225				
		R:	AT,	BE,	CH,	DE,	DK,	ES,	FR,	GB,	GR,	ΙΤ,	LI,	LU,	NL,	SE,	MC,	PT,	
			IE.	SI,	FI.	RO.	CY.	TR.	BG.	CZ_{-}	EE.	HU.	SK						

US 2005-538878

20050614

US 2006065184 Α1 20060330 PRAI JP 2003-10436 Α 20030117

WO 2003-JP16794 W 20031225 THERE ARE 1 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT RE.CNT 1

L9 ANSWER 2 OF 6 USPATFULL on STN

AΒ The present invention is a method phosphorus) - doped sillicoh single growth of the single crystal is performed so that

Al (aluminum) concentration is 2+10.sup 12
atoms/cc or more. Thereby, there can be provided method of easily and inexpensively producing

phosphorus)-doped silicon single

crystal of defect-free region having an/excellent capability of

electrical characteristics to be high breakdown voltage, which contains neither, for example, V region, OSF region, nor large dislocation cluster (LSEPD, LFPD) region. CAS INDEXING IS AVAILABLE FOR THIS PATENT Process for producing podo 2006:77212 USPATFULL doped n type silicon single crystal wafer Sakurada, Masahird shima, JAPAN Rukushima, JAPAŅ Fusegawa, Izumi, US 2006065184 Α1 20060330 US 2003-538878 Α1 20031225 WO 2003-JP16794 20031225 20050614 JP 2003-10436 20030117 Utility APPLICATION OLIFF & BERRIDGE, PLC, P.O. BOX 19928, ALEXANDRIA, VA, 22320, US Number of Claims: 29 Exemplary Claim: 1-9 4 Drawing Page(s) LN.CNT 535 CAS INDEXING IS AVAILABLE FOR THIS PATENT. ANSWER 3 OF 6 USPATFULL on STN A method of making an integrated electrooptic solid state device array comprising forming a structure having a multiplicity of active, solid state electrooptic component bobies in a solid state device material, including arranging the componeht bodies in a geometrical pattern and forming the component bodies to a prespecified size of less than 15 microns each and to an accuracy to within a fraction of a micron, and providing at least one electronic rectifying barrier at each of the component bodies for the operation of each component body as an active solid state electrooptic component. CAS INDEXING IS AVAILABLE FOR THIS PATENT. 87:61798 USPATFULL Method of making active solid state devices Li, Chou H., 379 Elm Dr., Roslyn NY, United States 11576 US 4690714 19870901 US 1983-462374 19830131 (6) Continuation-in-part of Ser. No. \$\square\$S 1979-7584, filed on 29 Jan 1979, now patented, Pat. No. US 4371406 which is a continuation of Ser. No. US 1977-764433, filed on 31 Jan 1977, now patented, Pat. No. US 4136435 which is a continuation of Ser. No. US 1973-405138, filed on 10 Oct 1973, now abandoned And Ser. No. US 1975-580414, filed on 23 May 1975, now abandoned , said Ser. No. 405138 And Ser. No. 580414 , each which is a continuation-in-part of Ser. No. US 1971-190483, filed on 19 Oct 1971, now patented, Pat. No. U\$ 3765956 Ser. No. Ser. No. US 1973-386102, filed on 6 Aug 1973 And Ser. No. US 1969-802018, filed on 25 Feb 1969, now patented, Pat. No. US 3500135 , said Ser. No. which is a continuation-in-part of Ser. No. US 1969-868129, filed on 21 Oct 1969, now abandoned which is a continuation-in-part of Ser. No. US 1965-491718, filed on 30 Sep 1965, now abandoned , said Ser. No. 802018 which is a continuation-in-part of Ser. No. US 1965-490955, filed on 28 Sep 1965, now patented, Pat. No. US 3430109 Utility Granted Primary Examiner: Ozaki, George T. Cooper, Dunham, Griffin & Moran Number of Claims: 25 Exemplary Claim: 1 18 Drawing Figure(s); 2 Drawing Page(s)

L9 ANSWER 4 OF 6 USPATFULL on STN

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

ΑN TΙ

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ECL

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EXNAM

LREP

CLMN

ECL

DRWN

LN.CNT 1468

RLI

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The ultra-miniaturized, active solid-state devices and circuitries have unique material bodies having signal-translating regions attached thereto for active signal translation. These regions, comprising melt-grown, or simulated melt-grown, metallurgical compounds including oxides, eutectics, and intermetallics, are of controlled compositions, concentration profiles, and electronic or other optoelectromagnetic properties. In some devices, the mi¢rostructure of the compounds comprises a plurality of microscopi¢ally thin, regularly-shaped and uniformly-spaced bodies of one phase material dispersed in a matrix of another phase material. The electronic conductivity of the bodies is substantially different from that of the matrix, and the bodies all terminate at microscopic distance from the pn junction (or other interfacial rectifying barrier region), so as to confine the signal current carries to flow mainly in only one of the phases. This achieves carriers microstreaming or microbrandhing effects. Described also herein are different devices including micron-size eutectic devices, dendritic devices, cellular devices, and granular devices; and their methods of manufacture. The barrier regions may be further modified by diffusion,ion implantation, selective oxidation, electrolytic etching, and surface-contouring. In addition, selected circuit elements may be embedded into these devices to achieve additional carriers movement control or to obtain special beneficial effects.

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CAS INDEXING IS AVAILABLE FOR THIS PATENT.
ΑN
       83:5251 USPATFULL
ΤI
       Solid-state device
IN
       Li, Chou H., 379 Elm Dr., Roslyn, NY, United States 11576
PΙ
       US 4371406
                               19830201
AΙ
       US 1979-7584
                               19790129 (6)
DCD
       19960130
RLI
       Continuation of Ser. No. US 1977-764433, filed on 31 Jan 1977, now
       patented, Pat. No. US 4136435 which is \phi continuation of Ser. No. US
       1973-405138, filed on 10 Oct 1973, now abandoned And Ser. No. US
       1975-580414, filed on 23 May 1975, now abandoned, said Ser. No.
       405138 And Ser. No.
                              580415 , each which is a continuation-in-part of
       Ser. No. US 1971-190483, filed on 19 Oct 1971, now patented, Pat. No. US
       3765956 And a continuation-in-part of Ser. No. US 1973-386102, filed on
       6 Aug 1973, now Defensive Publication No. And a continuation-in-part of
       Ser. No. US 1969-802018, filed on 25 Feb 1969, now patented, Pat. No. US
       3500135 , said Ser. No.
                                  190483 which is a continuation-in-part of
       Ser. No. US 1969-868129, filed on 21 Oct 1969, now abandoned which is a
       continuation-in-part of Ser. No. US 1965 491718, filed on 30 Sep 1965,
       now abandoned , said Ser. No.
                                        802018 which is a continuation-in-part
       of Ser. No. US 1965-490955, filed on 28 Sep 1965, now patented, Pat. No.
       US 3430109
DT
       Utility
FS
       Granted
EXNAM
       Primary Examiner: Ozaki, G.
CLMN
       Number of Claims: 26
ECL
       Exemplary Claim: 1
DRWN
       18 Drawing Figure(s); 2 Drawing Page(s)
LN.CNT 1309
CAS INDEXING IS AVAILABLE FOR THIS PATENT
L9
     ANSWER 5 OF 6 USPATFULL on STN
AB
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The ultra-miniaturized, active solid-state devices and circuitries have unique material bodies having signal-translating regions attached thereto for active signal translation. These regions, comprising melt-grown, or simulated melt-grown, metallurgical compounds including oxides, eutectics, and intermetallics, are of controlled compositions, concentration profiles, and electronic or other optoelectromagnetic properties. In some devices, the microstructure of the compounds comprises a plurality of microscopically thin, regularly-shaped and uniformly-spaced bodies of one phase material dispersed in a matrix of another phase material. The electronic conductivity of the bodies is substantially different from that of the matrix, and the bodies all terminate at microscopic distance from the pn junction (or other interfacial rectifying barrier region), so as to confine the signal current carriers to flow mainly in only one of the phases. This achieves

carriers microstreaming or microbranching effects. Described also herein are different devices including micron-size eutectic devices, dendritic devices, cellular devices, and granular devices; and their methods of manufacture. The barrier regions may be further modified by diffusion, ion implantation, selective oxidation, electrolytic etching, and surface-contouring. In addition, selected circuit elements may be embedded into these devices to achieve additional carriers movement control or to obtain special beneficial effects.

This is a continuation of my pending applications Ser. Nos. 405,138 and 580,414, filed Oct. 10, 1973 and May 23, 1975, respectively, Both of which are continuations-in-part of applications Ser. Nos. 190,483, 386,102, and 802,018, filed Oct. 19, 1971, Aug. 6, 1973, and Feb. 25, 1969, respectively. The 190,483 application is a continuation-in-part of application Ser. Number 868,129 filed Oct. 21, 1969 which, in turn, is a continuation-in-part of application Ser. Number 491,718 filed Sept. 30, 1965. The 802,018 application is a continuation-in-part of application Ser. Number 490,955 filed Sept. 28, 1965. The 405,138, 868,129, and 491,718 applications are now abandoned while the 190,483, 802,018, and 490,955 applications have since matured into U.S. Pat. Nos. 3,765,956, 3,500,135, and 3,430,109, respectively. I hereby incorporate all these related applications by reference.

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CAS INDEXING IS AVAILABLE FOR THIS PATENT.
ΑN
       79:4825 USPATFULL
TΙ
       Method for making solid-state device
ΙN
       Li, Chou H., 379 Elm Dr., Roslyn, NY,
                                              United States 11576
PΙ
       US 4136435
                                19790130
AΙ
       US 1977-764433
                                19770131 (5)
DT
       Utility
FS
       Granted
EXNAM
       Primary Examiner: Ozaki, G.
CLMN
       Number of Claims: 17
ECL
       Exemplary Claim: 1
       18 Drawing Figure(s); 2 Drawing Page(s)
DRWN
LN.CNT 1310
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
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L9 ANSWER 6 OF 6 USPATFULL on STN

AΒ

The ultra-miniaturized, active solid-state devices and circuitries have unique material bodies having signal-translating regions attached thereto for active signal translation. These regions, comprising melt-grown, or simulated melt-grown, metallurgical compounds including oxides, eutectics, and intermetallics, are of controlled compositions, concentration profiles, and electronic or other optoelectromagnetic properties. In some devices, the microst cucture of the compounds comprises a plurality of microscopically thin, regularly-shaped and uniformly-spaced bodies of one phase material dispersed in a matrix of another phase material. The electronic conductivities of the bodies are substantially different from that of the matrix, and the bodies all terminate at microscopic distance from the pn junction (or other interfacial rectifying barrier region), sp as to confine the signal current carriers to flow mainly in only one of the phases. This achieves carriers microstreaming or microbranching effects. Described also herein are different devices including micron-site eutectic devices, dendritic devices, cellular devices, and granular devices; and their methods of manufacture. The barrier regions may be further modified by diffusion, ion implantation, selective oxidation, electrolytic etching, and surface-contouring. In addition, selected ξ ircuit elements may be embedded into these devices to achieve additional carriers movement control or to obtain special beneficial effects.

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CAS INDEXING IS AVAILABLE FOR THIS PATENT.

AN 73:47845 USPATFULL

TI SOLID-STATE DEVICE

IN Li, Chou H., 379 Elm Dr., Roslyn, NY, United States 11576

PI US 3765956 19731016

AI US 1971-190483 19711019 (5)

RLI Continuation-in-part of Ser. No. US 1969-868129, filed on 21 Oct 1969,
```

now abandoned And Ser. No. US 1969-802018, filed on 25 Feb 1969, now patented, Pat. No. US 3500135 Utility Granted

EXNAM

Primary Examiner: Rutledge, L. Dewayne; Assistant Examiner: Davis, J. M. Number of Claims: 27

CLMN

DRWN 12 Drawing Figure(s); 1 Drawing Page(s)

LN.CNT 1368

CAS INDEXING IS AVAILABLE FOR THIS PATENT

DT

FS